

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
08/558,544	11/16/1995	SHUNPEI YAMAZAKI	0756-1441	3919		
31780 7	590 03/17/2003					
	ERIC ROBINSON			EXAMINER		
PMB 955 21010 SOUTH			KANG, DONGHEE			
POTOMACEA	ALLS, VA 20165		ART UNIT	PAPER NUMBER		
			2811			
			DATE MAILED: 03/17/2003	1		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	4h
Office Action Summary				
		08/558,544 YAMAZAKI, SHUNPEI		
		Examiner	Art Unit	
	The MAILING DATE of this communication ap	Donghee Kang	2811	
A SH THE I	ORTENED STATUTORY PERIOD FOR REPL MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.* SIX (6) MONTHS from the mailing date of this communication.	LY IS SET TO EXPIRE 3 N	IONTH(S) FROM	.55
- Failu	period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period re to reply within the set or extended period for reply will, by statute eply received by the Office later than three months after the mailing dipatent term adjustment. See 37 CFR 1.704(b).	will apply and will expire SIX (6) MON	ITHS from the mailing date of this comm	unication.
1)🖂	Responsive to communication(s) filed on 25	February 2003 .		
2a)⊠		nis action is non-final.		
3) 🗌 Dispositi	Since this application is in condition for allow closed in accordance with the practice under on of Claims	ance except for formal main <i>Ex parte Quayle</i> , 1935 C.I	tters, prosecution as to the m D. 11, 453 O.G. 213.	nerits is
	Claim(s) 1-59 is/are pending in the application			
l	4a) Of the above claim(s) is/are withdra			
5)⊠	Claim(s) <u>1-4,6,14-18,20,23-28,36-39,44,47,51</u>	<u>,54,57 and 59</u> is/are allowe	ed.	
6)⊠	Claim(s) <u>5,8,9,11-13,19,22,29-32,34,35,40,48</u>	- <u>50,52,53,55,56 and 58</u> is/	are rejected.	
7)🖂	Claim(s) <u>7,10,21,33,38,41-43,and 45-46</u> is/are	objected to.		
	Claim(s) are subject to restriction and/o on Papers	r election requirement.		
9)□ T	he specification is objected to by the Examine	r.		
10)[] T	he drawing(s) filed on is/are: a) accep	oted or b) objected to by th	ne Examiner.	
	Applicant may not request that any objection to the			
11)[] T	he proposed drawing correction filed on			
	If approved, corrected drawings are required in rep		,	
12) 🗌 T	he oath or declaration is objected to by the Ex	aminer.		
Priority u	nder 35 U.S.C. §§ 119 and 120			
13) 🗌 📝	Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. §	119(a)-(d) or (f)	
	All b) Some * c) None of:	•	(-) (-) (-)	
	I. Certified copies of the priority documents	s have been received.		
2	2. Certified copies of the priority documents		polication No	
	B. Copies of the certified copies of the prior application from the International Buree the attached detailed Office action for a list of	ity documents have been reau (PCT Rule 17.2(a))	eceived in this National Stag	je
	knowledgment is made of a claim for domestic			lication)
a)	☐ The translation of the foreign language prov cknowledgment is made of a claim for domestic	visional application has be	en received.	noaduli).
Attachment(o priority under 00 0.0.0.	33 120 aliu/01 121.	
1) Notice 2) Notice 3) Informa	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of In	ummary (PTO-413) Paper No(s) formal Patent Application (PTO-152	· !)
S. Patent and Trad TO-326 (Rev.		ion Summary	Part of Paper	

Art Unit: 2811

DETAILED ACTION

Acknowledgment

1. Applicant's Amendment and Response to Paper No.39 has been entered and made of Record.

Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims **8,19, 22, 29, 30, 48, 49, 52, 53 & 55** are rejected under 35 U.S.C. 103(a) as being unpatentable over Koji (JP 2,143,572) in view of Morozumi (US 4,862,237).

Regarding claim **19**, Koji discloses a device for sensing a light comprising (Fgi.3G):

a semiconductor layer (2) over an insulating substrate (1); a photoelectric conversion semiconductor device on said substrate, a semiconductor region of the photoelectric conversion semiconductor device comprising a p-type impurity (201) semiconductor region, an intrinsic semiconductor region (2-2), and an n-type impurity semiconductor region (2-3); and a thin film transistor over the substrate, an active layer of the thin film transistor comprising a source region, a drain region, and a channel region;

wherein said semiconductor regions are arranged in order with said p-type impurity semiconductor region adjacent said intrinsic semiconductor region and said

Art Unit: 2811

intrinsic semiconductor region adjacent said n-type impurity semiconductor region in said photoelectric conversion semiconductor device, said order being in a direction perpendicular to that in which a light to be sensed is incident thereon, and wherein the semiconductor region of the potoelectric conversion semiconductor device and the active layer of the thin film transistor comprise the same semiconductor layer.

Although the device of Koji was not fabricated by same process step as claimed invention, the resultant structure of the process steps in claims are anticipated by Koji.

The product-by-process claims are given no patentable weight. "Even though product-by-process claims are limited by and defined by the process, determination of patentability is based on the product itself. The patentability of a product does not depend on its method of production.

If the product in the product-by-process claim is the same as or obvious from a product of the prior art, the claim is unpatentable even though the prior product was made by a different process". In re Thorpe, 777F. 2d 695,698 USPQ 964, 966 (Fed. Cir.1985). See also MPEP 2113. Moreover, an old or obvious product produced by a new method is not a patentable product, whether claim in "product by process" claim or not.

Koji does not teach forming SiO₂ layer on the insulating substrate. However, Morozumi in Fig.4 teaches forming a TFT and light sensor on the insulating substrate (20) covered over entire are of its surface with a SiO₂ (21). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to

Art Unit: 2811

substitute the insulating substrate of Koji with the insulating substrate covered with silicon oxide as taught by Morozumi in order to improve the signal to noise ratio.

Regarding claims **8, 22, 29 & 30**, Koji discloses a device for sensing a light comprising (Fig.3G):

a light sensor region and a semiconductor switch region (TFT) adjacent to and operatively connected with said light sensor region over an insulating substrate, wherein a semiconductor region of the light sensor region and an active region of the semiconductor switch region comprising the same semiconductor layer formed on the insulating substrate. Koji does not teach forming SiO₂ layer on the insulating substrate.

However, Monozumi teaches forming a TFT and light sensor on the insulating substrate (20) covered entire area of its surface with silicon oxide film (21). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to substitute the insulating substrate of Koji with the insulating substrate covered with silicon oxide as taught by Morozumi in order to improve the signal to noise ratio.

Neither Koji nor Monozumi teaches the semiconductor layer has at least one of an electron mobility in a range of 15 to 300 cm²/Vsec and a hole mobility in a rang of 10 to 200 cm²/Vsec. However, a desired the electron mobility and hole mobility can be achieved by varying n and p type dopant concentration. Therefore, it would have been obvious in the art at the time the invention was made to obtain the electron mobility in a range of 15 to 300 cm²/Vsec and hole mobility in a rang of 10 to 200 cm²/Vsec by changing n and/or p type dopant concentration in the device in order to obtain a desired spped of the device.

Page 5

Application/Control Number: 08/558,544

Art Unit: 2811

Regarding claims **48,49,52,53 & 55**, Koji as modified by Morozumi teaches the light sensor device uses in the electric equipment, such as a facsimile machine and image sensor.

4. Claims **5**, **9**,**11-13**, **31**, **32**, **34-35**, **40**, **48**, **50**, **56 & 58** are rejected under 35 U.S.C. 103(a) as being unpatentable over Koji in view of Morozumi and further in view of Misawa et al. (US 5,250,931).

Regarding claim **5**, Koji discloses a device for sensing a light comprising (Fgi.3G):

a semiconductor layer (2) over an insulating substrate (1); a photoelectric conversion semiconductor device on said substrate, a semiconductor region of the photoelectric conversion semiconductor device comprising a p-type impurity (201) semiconductor region, an intrinsic semiconductor region (2-2), and an n-type impurity semiconductor region (2-3); and a thin film transistor over the substrate, an active layer of the thin film transistor comprising a source region, a drain region, and a channel region;

wherein said semiconductor regions are arranged in order with said p-type impurity semiconductor region adjacent said intrinsic semiconductor region and said intrinsic semiconductor region adjacent said n-type impurity semiconductor region in said photoelectric conversion semiconductor device, said order being in a direction perpendicular to that in which a light to be sensed is incident thereon, and wherein the

Art Unit: 2811

semiconductor region of the potoelectric conversion semiconductor device and the active layer of the thin film transistor comprise the same semiconductor layer.

Although the device of Koji was not fabricated by same process step as claimed invention, the resultant structure of the process steps in claims are anticipated by Koji.

The product-by-process claims are given no patentable weight. "Even though product-by-process claims are limited by and defined by the process, determination of patentability is based on the product itself. The patentability of a product does not depend on its method of production.

Koji does not teach forming SiO₂ layer on the insulating substrate. However, Morozumi in Fig.4 teaches forming a TFT and light sensor on the insulating substrate (20) covered over entire are of its surface with a SiO₂ (21). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to substitute the insulating substrate of Koji with the insulating substrate covered with silicon oxide as taught by Morozumi in order to improve the signal to noise ratio.

Neither Koji nor Morozumi teaches the semiconductor switch comprises complementary p-channel and n-channel thin film transistor. However, Misawa et al. teach in Fig.4D the driver circuit portion comprises p-channel and n-channel thin film transistors (132 & 133). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teaching of Misawa with Koji as modified by Morozumi, since the complementary p-channel and n-channel thin film transistors requires a small power to operate the device. Such modification provides Koji's device with lower power consumption.

Art Unit: 2811

Regarding claims **9 & 11-12**, Koji teaches a semiconductor device comprising (Fig.3G):

a light sensor region and a semiconductor switch region (TFT) adjacent to and operative connected with said light sensor region over an insulating substrate, wherein a semiconductor region of the light sensor region and an active region of the semiconductor switch region comprise the same semiconductor layer (polycrystalline Si) formed on the insulating substrate, wherein a Raman spectrum of the semiconductor layer (polycrystalline Si) exhibits a peak deviated from that which stands for a single crystal for the semiconductor,

wherein said light sensor region comprises at least two semiconductor regions .
having different electrical properties and forming a junction,

wherein said two semiconductor regions in said light sensor region are arranged in a lateral direction on said substrate.

Koji does not teach forming a SiO₂ layer on the insulating substrate. However, Morozumi in Fig.4 teaches forming a TFT and light sensor on the insulating substrate (20) covered over entire are of its surface with a SiO₂ (21). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to substitute the insulating substrate of Koji with the insulating substrate covered with silicon oxide as taught by Morozumi in order to improve the signal to noise ratio. Neither Koji nor Morozumi teaches the semiconductor switch comprises complementary p-channel and n-channel thin film transistor. However, Misawa et al. teach in Fig.4D the driver circuit portion comprises p-channel and n-channel thin film transistors (132 &

Art Unit: 2811

133). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teaching of Misawa with Koji as modified by Morozumi, since the complementary p-channel and n-channel thin film transistors requires a small power to operate the device. Such modification provides Koji's device with lower power consumption.

Regarding claim 13, cited prior arts do not teach the semiconductor layer has at least one of an electron mobility in a range of 15 to 300 cm²/Vsec and a hole mobility in a rang of 10 to 200 cm²/Vsec. However, the electron mobility and hole mobility can be varied with changing n and p type dopant concentration in the semiconductor layer to obtain a desired device. Therefore, it would have been obvious in the art at the time the invention was made to vary the electron mobility and hole mobility in the device in order to obtain a desired speed of the device.

Regarding claims **31-32 & 58**, Koji teaches a semiconductor device comprising (Fig.3G):

an insulating substrate, first and second islands on said substrate; p-type impurity region in said first semiconductor island with a first channel region interposed therebetween and in a first region of said third semiconductor island; an insulating film (4) on said first and second semiconductor islands; a gate electrode (2-1) over said first channel regions with said insulating film interposed therebetween,

wherein a Raman spectrum of each of said first and second semiconductor islands exhibits a peak deviated from that which stands for single crystal of the semiconductor. Koji does not teach forming SiO₂ layer on the insulating substrate.

However, Monozumi teaches forming a TFT and light sensor on the insulating substrate (20) covered entire area of its surface with silicon oxide film (21). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to substitute the insulating substrate of Koji with the insulating substrate covered with silicon oxide as taught by Morozumi in order to improve the signal to noise ratio.

Neither Koji nor Morozumi teaches the semiconductor switch comprises complementary p-channel and n-channel thin film transistor. However, Misawa et al. teach in Fig.4D the driver circuit portion comprises p-channel and n-channel thin film transistors (132 & 133). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teaching of Misawa with Koji as modified by Morozumi, since the complementary p-channel and n-channel thin film transistors requires a small power to operate the device. Such modification provides Koji's device with lower power consumption.

Regarding claims **34-35 & 40**, cited prior arts do not teach p-type impurity regions contains boron and n-type impurity regions contains phosphorous. However, it is conventional to use boron when p-type implants are required and phosphorous when n-type implants are required. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to use boron for p-type and phosphorous for n-type since they are known materials well suited for intended purpose.

Regarding claims **48, 50 & 56**, Koji teaches the light sensor device uses in the electric equipment, such as a facsimile machine and image sensor.

Allowable Subject Matter

Page 10

Application/Control Number: 08/558,544

Art Unit: 2811

5. Claims 1-4, 6,14-18, 20-28,36-39, 44,47,51,54,57 & 59 are allowed in the previous office action.

6. Claims 7, 10, 21, 33, 38, 41, 42, 45, 4, & 47 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Response to Arguments

7. Applicant's arguments filed 25 February 2003 have been fully considered but they are not persuasive. In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988)and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, forming oxide layer on the insulating substrate will reduce noise hence improving the signal to noise ratio as taught by Morozumi. With respect to combine the teaching of Morozumi with the Koji's device, the noise will be reduce so as to improve the signal to noise ratio in Koji's device.

Conclusion

8. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

9. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Donghee Kang whose telephone number is 703-305-9147. The examiner can normally be reached on Monday through Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on 703-308-2772. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

dhk

March 11, 2003

Ster Sohe

Page 11